

Power F-MOS FETs

2SK2123

Silicon N-Channel Power F-MOS FET

■ Features

- Avalanche energy capacity guaranteed: EAS > 100mJ
 - $V_{GSS} = \pm 30V$ guaranteed
 - High-speed switching: $t_f = 35ns$
 - No secondary breakdown

■ Applications

- Contactless relay
 - Diving circuit for a solenoid
 - Driving circuit for a motor
 - Control equipment
 - Switching power supply

■ Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Drain to Source breakdown voltage	V _{DSS}	450	V
Gate to Source voltage	V _{GSS}	±30	V
Drain current	DC	I _D	±5
	Pulse	I _{DP}	±15
Avalanche energy capacity	EAS*	100	mJ
Allowable power dissipation	T _C = 25°C	P _D	50
	T _a = 25°C		2
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* L = 8mH, I_L = 5A, V_{DD} = 50V, 1 pulse

■ Electrical Characteristics ($T_C = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I _{PSS}	V _{DS} = 360V, V _{GS} = 0			0.1	mA
Gate to Source leakage current	I _{GSS}	V _{GS} = ±30V, V _{DS} = 0			±1	µA
Drain to Source breakdown voltage	V _{DSS}	I _D = 1mA, V _{GS} = 0	450			V
Gate threshold voltage	V _{th}	V _{DS} = 25V, I _D = 1mA	2		5	V
Drain to Source ON-resistance	R _{DSS(on)}	V _{GS} = 10V, I _D = 3A		1	1.3	Ω
Forward transfer admittance	Y _{fs}	V _{DS} = 25V, I _D = 3A	2	2.5		S
Diode forward voltage	V _{DSF}	I _{DR} = 5A, V _{GS} = 0			-1.2	V
Input capacitance (Common Source)	C _{iss}	V _{DS} = 20V, V _{GS} = 0, f = 1MHz		700		pF
Output capacitance (Common Source)	C _{oss}			100		pF
Reverse transfer capacitance (Common Source)	C _{rss}			40		pF
Turn-on time (delay time)	t _{d(on)}	V _{GS} = 10V, I _D = 3A V _{DD} = 150V, R _L = 50Ω		25		ns
Rise time	t _r			45		ns
Fall time	t _f			35		ns
Turn-off time (delay time)	t _{d(off)}			80		ns
Thermal resistance between channel and case	R _{th(ch-c)}				2.5	°C/W





